

SMD Auto COG HV Flex, Ceramic, 0.039 uF, 5%, 1000 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, Automotive Grade, 2225



Dimensions	
Chip Size	2225
L	5.9mm +/-0.75mm
W	6.4mm +/-0.4mm
T	2.5mm +/-0.20mm
B	0.7mm +/-0.35mm

Packaging Specifications	
Packaging:	T&R, 180mm, Plastic Tape
Packaging Quantity:	500

General Information	
Series:	SMD Auto COG HV Flex
Style:	SMD Chip
Description:	SMD, MLCC, FT-CAP, Ultra-Stable, Automotive Grade
Features:	FT-CAP, Ultra-Stable, Automotive Grade
RoHS:	Yes
Termination:	Flexible Termination
Marking:	No
Qualifications:	AEC-Q200
AEC-Q200:	Yes
Component Weight:	390 mg
Shelf Life:	78 Weeks
MSL:	1

Specifications	
Capacitance:	0.039 uF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	5%
Voltage DC:	1000 VDC
Dielectric Withstanding Voltage:	1200 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor:	0.1% 1 kHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	25.641 GOhms

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